DECLARATION FOR PATENT APPLICATION AND APPOINTMENT OF ATTORNEY

As a below named inventor. I hereby declare that my residence, post office address and citizenship are as stated below next to my name. I believe that I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention (Design, if applicable) entitled SEMICOMDUCTOR PACKAGING STRUCTURE

the specification of which (check one)

X is attached hereto

☐ was filed on

12

as Application Serial No.

and (if applicable) was amended on

I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claims, as amended by any amendment(s) referred to above I acknowledge the duty to disclose information which is material to patentiability as defined in Title 37, Code of Federal Regulations, § 1.56. I hereby claim foreign priority benefits under Title 35, United States Code § 119 of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application on which priority is claims.

PRIOR FOREIGN APPLICATION(S)		PRIORITY CLAIMED		
Number	Country	Day/Month/Year Filed	Yes	No

I hereby claim the benefit under *Title 35*, *United States Code*, \$ 120 of any United States application(s) or PCT international applications) designating. The United States of America listed below and, insofar as the subject matter of each of the claims of the pipilication is not disclosed in that those prior application(s) in the manner provided by the first paragraph of *Title 35*, *United States Code*, \$ 112, 1 acknowledge the duty to disclose information which is material to patentability as defined in *Title 37*, *Code of Federal Megulations*, \$ 1.56 which became available between the filing date of the prior application(s) and the national or PCT international behavior of this application.

Application Number	Filing Date	Status - Patented, Pending or Abandonded
Q.		
		<u> </u>

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are, believed to be true, and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under section 1001 of title 18 of the United States Code and that such willful false statements may peopardize the validity of the application or any patent issued thereon

POWER OF ATTORNEY I(We) hereby appoint as my(our) attorneys, with full powers of substitution and revocation, to prosecute

Thomas E. Sisson 29348; Mark H. Miller 29197;

Daniel D. Chapman 32726; William B. Nash 33743

I(We) authorize my(our) attorneys to accept and follow instructions from TALE INTERNATIONAL PATENT & LAW OFFICE regarding any, matter related to the preparation, examination, grant and maintenance of this application, any continuation, continuation-part or divisional based thereon, and any patent resulting therefrom, until I(We) or my(our) assigns withdraw thorization in writing Sept correspondence to Jackson Walker L.L.P.

Telephone Calls to (210) 978-7700

112 E. Pecan Street Suite 2100 San Antonio, TX 78205

Attn: Thomas E. Sisson

U.S.A. Full Name of First or Sole Inventor Cheng-Ho HSU Citizenship Taiwan, R.O.C. Post Office Address

Same as Residence Residence Address No. 238, Lane 301, Kai-Feng Rd., Hsin-Hsing Dist., Kaohsiung, Taiwan, R.O.C. SIGNATURE DATE CHENG-HO HSU October 8, 2001 Full Name of Joint Inventor Yi-Hua CHANG Citizenship Taiwan, R.O.C. Post Office Address Same as Residence Residence Address 6F, No. 10-1, Lane 578, Chung-Lun-Erh Rd., Feng-Shan City, Kaohsiung Hsien, Taiwan, R.O.C. DATE SIGNATURE Yi- Dua Chan October 8, 2001

See following pages for additional joint inventors

DECLARATION FOR PATENT APPLICATION AND APPOINTMENT OF ATTORNEY

Page 2

Full Name of Joint Inventor Jen-Cheng LIOU	Ciazauhup Taiwan, R.O.C.
Resulence Address No. 59-1, Lane 190, Nan-Tzu-Hsin Rd., Kaohsiung, Taiwan, R.O.C.	Post Office Address R Sume as Residence
October 8, 2001	SIGNATURE Jeh-Cheng LTOU
Full Name of Joint Inventor	Cinzenshup
Residence Address	Post Office Address Same as Residence
_OATE	SIGNATURE
id O	
Full Name of Joins Inventor	Clazenshup
Residence Address	Post Office Address Same as Residence
DATE	SIGNATURE
2 &	
Full Name of Jons Inventor	Citizouthip
Full Name of Ions Investor Residence Address	Clitenship Poss Office Address Same as Rendance
. Residence Address	Poss Office Address Some as Rendence
. Residence Address	Poss Office Address Some as Rendence
, Residence Address DATE	Poss Office Address Sume as Rendence . SIGNATURE
Residence Address DATE Full Name of Join Inventor	Poss Office Address Signature Signature Citemphip
Residence Address DATE Full Name of Join Inventor	Poss Office Address Signature Signature Citemphip
Residence Address DATE Full Name of Joins Inventor Residence Address	Poss Office Address
Residence Address DATE Full Name of Joins Inventor Residence Address	Poss Office Address
Pate Pat Name of Iola Inventor Residence Address DATE Total Name of Iola Inventor Residence Address	Post Office Address Signature Signature Citemphip Post Office Address Sume as Residence Signature Signature
Pull Name of Jons Inventor Full Name of Jons Inventor Residence Address DATE Full Name of Jons Inventor	Post Office Address Signature Citemohip Post Office Address Signature Signature Ciacouring Ciacouring

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of

Inventor(s): Cheng-Ho HSU; Yi-Hua CHANG; Jen-Cheng LIOU

Title:

POWER OF ATTORNEY

Hon. Commissioner of Patents and Trademarks Washington, D.C. 20231

Sir:

Taiwan IC Packaging Corporation

having become the owner of all rights in and to the aboveidentified application by virtue of an Assignment executed by the inventor(s) concurrently with the execution of the application, said Assignment being submitted herewith for recording, hereby appoints:

Thomas E. Sisson 29348; Mark H. Miller 29197; Daniel D. Chapman 32726; William B. Nash 33743

Whose address is:Jackson Walker L.L.P.
112 E. Pecan Street
Suite 2100
San Antonio, TX 78205
U.S.A.

their attorneys to prosecute said application and to transact in connection therewith all business in the Patent and Trademark office and before competent International Authorities.

Date:	October 8, 2001	Hsi-Che Teng
Dace.		

Legal Representative: Hsi-Che TENG

▼INSTRUCTIONS

SMALL BUSINESS

VERIFIED STATEMENT (DECLARATION) CLAIMING SMALL ENTITY STATUS (37 CFR 1.9(f) AND 1.27(c)) - SMALL BUSINESS CONCERN

	(37 CFR 1.9(f) AND 1.27(c)) - SMALL BUSINESS CONCERN
check one [nsert company name and iddress [hereby declare that I am a) (x) the owner of the small business concern identified below: b) () an official of the small business concern empowered to act on behalf of the concern identified below: NAME OF CONCERN: Taiwan IC Packaging Corporation ADDRESS OF CONCERN: 2, South 3rd Rd., K.E.P.Z. Kaohsiung,
	Taiwan, R.O.C.
nsert title of	I hereby declare that the above identified small business concern qualifies as a small business concern as defined in 13 CFR 121.3-18, and reproduced in 37 CFR 1.9(d), for purposes of paying reduced fees under section 41(a) and (b) of Title 35, United States Code, in that the number of employees of the concern, including those of its affiliates, does not exceed 500 persons. For purpose of this statement, (1) the number of employees of the business concern is the average over the previous fiscal year of the concern of the persons employed on a full-time, part-time or temporary basis during each of the pay periods of the fiscal year, and (2) concerns are affiliates of each other when either, directly or indirectly, one concern controls or has the power to control the other, or a third party or parties controls or has the power to control both.
application,	I hereby declare that rights under contract or law have been conveyed to and remain with the sma
nventor's råmes	business concern identified above with regard to the invention, entitled SEMICONDUCTOR PACKAGING STRUCTURE by inventor(s) Chenca-Ho, HSU:
Ž	business concern identified above with regard to the invention, entitled SEMICONDUCTOR PACKAGING STRUCTURE by inventor(s) Cheng-Ho HSU; Yi-Hua CHANG; Jen-Cheng LIOU described in a) (X) the specification filed herewith. b) () application serial no, filed
Sheck one, ill in if	a) (A) the specification line therewith. b) () application serial no, filed c) () patent no, issued
화 orc)	c) () patent no, issued
And the state state to the state of the stat	If the rights held by the above-identified small business concern are not exclusive, each individual concern or organization having rights to the invention is listed below and no rights to the invention are held by any person, other than the inventor, who could not qualify as a small business concern under 37 CFR 1.9(d) or by any concern which would not qualify as a small business concern under 37 CFR 1.9(d) or a nonprofit organization under 37 CFR 1.9(e). NOTE: Separate verified statement are required from each named person, concern or organization having rights to the invention averring to their status as small entities. (37 CFR 1.27)
nsert co-owners,	NAME
fany, and check a),b) or c) (ADDRESS a) () INDIVIDUAL b) () SMALL BUSINESS CONCERN c) () NONPROFIT ORGANIZATION
3),0) 01 0)	***
	ADDRESS
	a)() Hold Hold Old All Zallo
	I acknowledge the duty to file, in this application or patent, notification of any change in status resulting in loss of entitlement to small entity status prior to paying, or at the time of paying, the earliest of the issue fee or any maintenance fee due after the date on which status as a small entity is no longer appropriate. (37 CFR 1.28(b))
	I hereby declare that all statements made herein of my own knowledge are true and that all statement made on information and belief are believed to be true; and further that these statements were mad with the knowledge that willful false statements and the like so made are punishable by fine o imprisonment, or both under section 1001 of Title 18 of the United States Code, and that such willful false statements may jeopardize the validity of the application, any patent issuing thereof, or an patent to which this verified statement is directed.
nsert (NAME Hsi-Che TENG TITLE President ADDRESS 2. South 3rd Rd., K.E.P.Z. Kaobsiums, Taiwan, R.O.C.
Sign, date (ADDRESS 2, South 3rd Rd., K.E.P.Z. Kaohsiung, Taiwan, R.O.C. SIGNATURE HSi-Che Tong DATE october 8, 2001
	· J.

V910313